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EN2160: Electronic Design Realization

## Production Documents for Closed Loop Stepper Motor Project

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## Contents

1	Introd	duction	3
2	Block	Diagram	3
3	Hardv	ware Design	3
	3.1	Schematic	3
	3.2	Components	4
	3.3	PCB Layer Stackup	7
	3.4	PCB Layout	8
	3.5	Enclosure Design	9
4	Softwa	are Development	11
5	Estim	nated Cost Per Unit	11
6	Comp	oonent Datasheets	11

#### 1 Introduction

This production report details the development of a closed-loop stepper motor control system designed for high-performance and cost-effective motion control applications. This project focuses on building a dedicated motor driver from scratch using a Texas Instruments C2000 series microcontroller. The system implements Field-Oriented Control (FOC) and real-time feedback to achieve precise position and speed control, along with fault detection. The report outlines the complete production process, including hardware and software design, integration, testing and evaluation procedures, and cost estimation, providing a comprehensive plan for future scalability and manufacturing.

## 2 Block Diagram

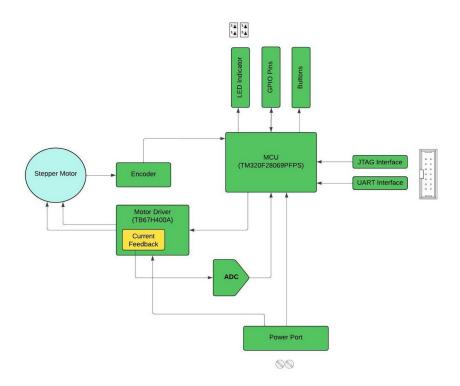
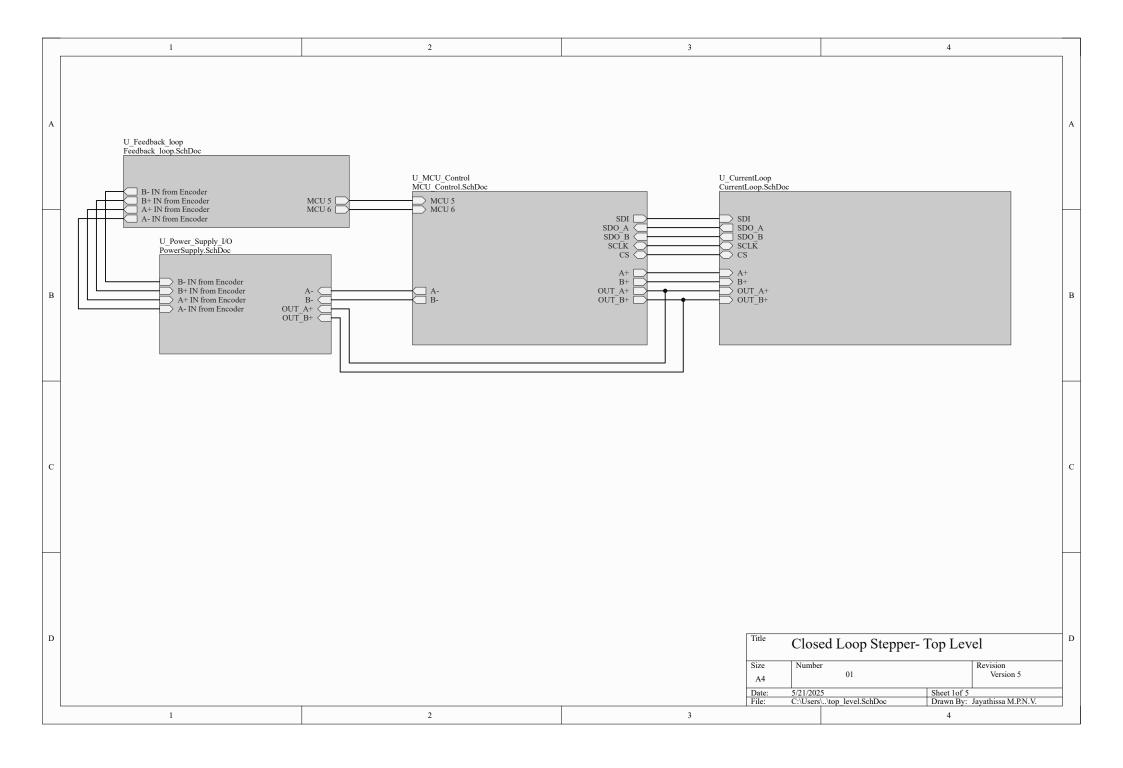
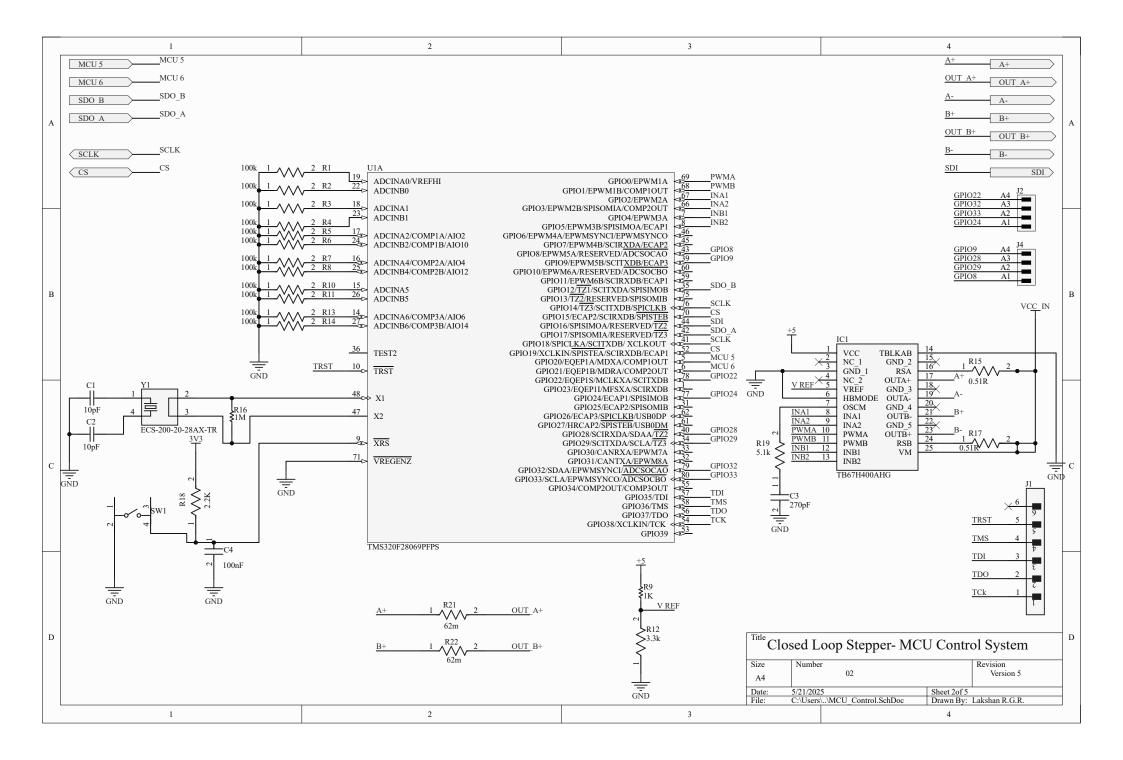


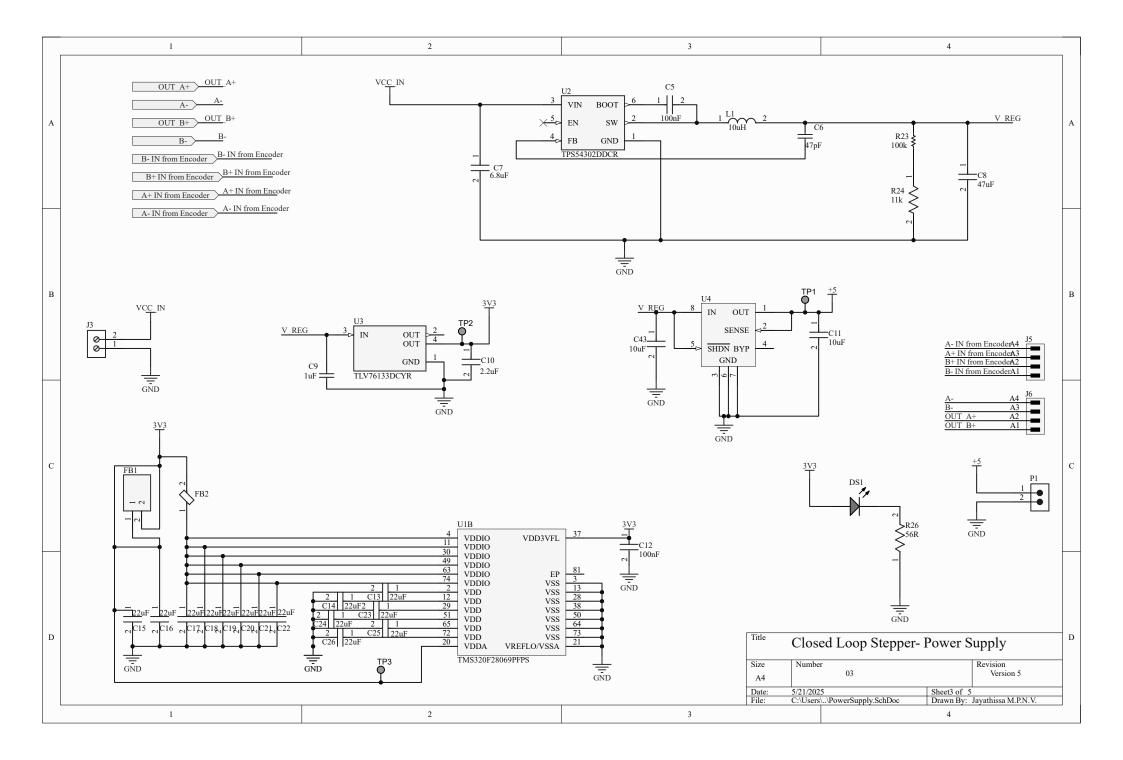
Figure 1: Block Diagram of the System

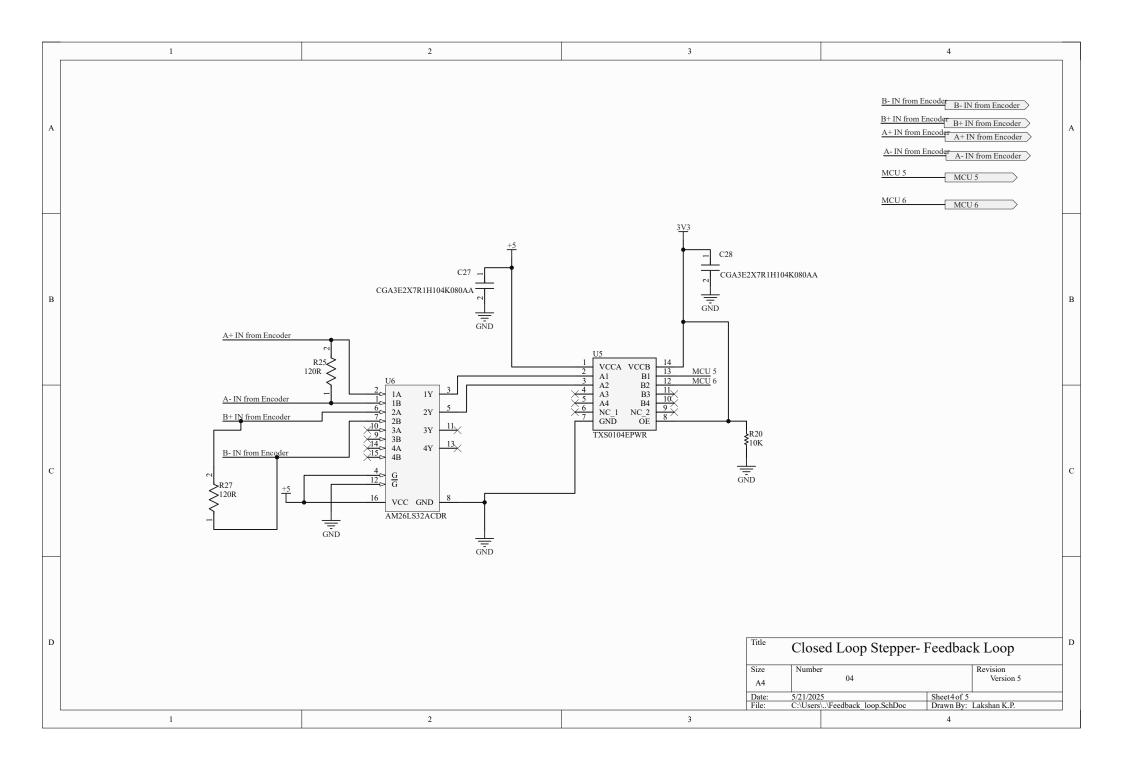
## 3 Hardware Design

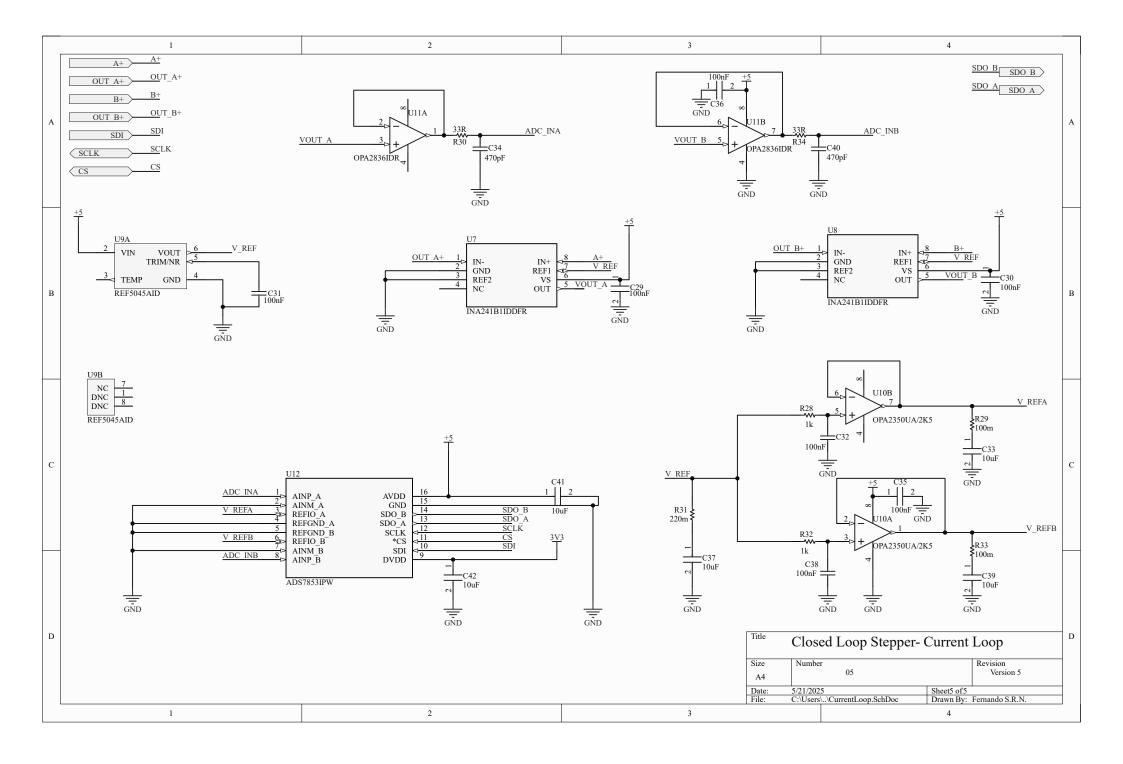
#### 3.1 Schematic











## 3.2 Components

Designator	Description	Manufacturer / Part		
		Number		
C1, C2	$10pF, \pm 5\%, 50V, 0603, NP0$	Yageo /		
		CC0603JRNPO9BN100		
C3	270pF, 50V, C0G/NP0, 0603	KEMET /		
		C0603C271J5GACTU		
C4, C12, C27, C28	100nF, 50V, X7R, 0603, Automotive	TDK /		
		CGA3E2X7R1H104K080AA		
C5	0.1uF, 50V, X7R, 0805	KEMET /		
		C0805C104M5RACTM		
C6	470pF, 50V, NP0, 0805	Murata /		
		GQM2195C1H470JB01D		
C7	6.8uF, 35V, X5R, 0805	TDK /		
		C2012X5R1V685K125AC		
C8	47uF, 16V, X5R, 1210	Murata /		
		GRM32ER61C476KE15L		
C9, C31, C32, C38	0.1uF, 50V, X7R, 0805	Kyocera AVX /		
		C0805C105K4PACTU		
C10	2.2uF, 100V, X7S, 1206	TDK /		
		C3216X7S2A225K160AB		
C11, C33, C37, C39,	10uF, 6.3V, X5R, 0603	Murata /		
C41-C43		GRM188R60J106ME47D		
C13-C26	22uF, 10V, X5R, 0603	Murata /		
		GRM188R61A226ME15D		
C29, C30, C35, C36	0.1uF, 100V, X7R, 1206	KEMET /		
		C1206C104K1RACTU		
C34, C40	470pF, 500V, 1206	Kyocera AVX /		
		12067A471JAT2A		
DS1	Green Chip LED, 2.2V	Broadcom Avago / HSMG-		
		C170		
FB2	$60\Omega, 100MHz, 0402FerriteBead$	Murata /		
		BLM15PD600SN1D		
J1	CONN HEADER VERT 6POS 2.54MM	Molex / 22-28-4060		
J2, J4–J6	Terminal Block, 3.50mm	Weidmuller / 1604490000		
J3	2-pin Terminal Block	Wurth Electronics /		
		691709710302		
L1	Inductor 10uH, 4.5A	Vishay Dale /		
		IHLP2525EZER100M01		
	<u> </u>			

Designator	Description	Manufacturer / Part Number		
P1	2-pin Header	Wurth Electronics / 691321100002		
R1-R14	$100\mathrm{k}\Omega, 1/16W, 0402$	Yageo / RC0402JR- 07100KL		
R9	$1 \mathrm{k}\Omega, 1\%, 0805$	Yageo / RC0805FR-071KL		
R12	$3.3\mathrm{k}\Omega,1\%,0805$	Vishay / CRCW08053K30FKEA		
R15, R17	$0.51\Omega, 1\%, 2W, 2512$	Stackpole / CSRN2512FTR510		
R16	$1\mathrm{M}\Omega, 5\%, 0603$	Panasonic / ERJ- 3GEYJ105V		
R18	$2.2\mathrm{k}\Omega,1\%,0603$	Vishay / CRCW06032K20FKEAHP		
R19	$5.1\mathrm{k}\Omega,1\%,0805$	Vishay / CRCW08055K10FKEA		
R20	$10\mathrm{k}\Omega,1\%,0805$	Yageo / RC0805FR- 0710KL		
R21, R22	$0.062\Omega, 1\%, 1W, 2512$	Rohm / MCR100JZHFSR062		
R23	$100\mathrm{k}\Omega,1\%,1206$	Bourns / CR1206-FX- 1003ELF		
R24	$11\mathrm{k}\Omega,1\%,1206$	Vishay / CRCW120611K0FKEA		
R25, R27	$120\Omega, 1\%, 1206$	Vishay / CRCW1206120RFKEA		
R26	$56\Omega, 5\%, 0603$	Vishay Dale / CRCW060356R0JNEA		
R28, R32	$1\mathrm{k}\Omega,1\%,1206$	Yageo / RC1206FR-071KL		
R29, R33	$100\mathrm{m}\Omega,1\%,1206$	Vishay Dale / WSL1206R1000FEA		
R30, R34	$33\Omega,1\%,1206$	Panasonic / ERJ- 8ENF33R0V		
R31	$0.22\Omega, 1\%, 1206$	Panasonic / ERJ- 8RQFR22V		
SW1	Tactile Switch SPST-NO, 0.05A 24V	TE Connectivity / 3- 1825910-1		
TP1-TP3	Test Point, Orange, THD	Keystone / 5003		
U1	Piccolo Microcontroller, 80-pin HTQFP	TI / TMS320F28069PFPS		
U2	Buck Regulator 3A, TSOT-23-6	TI / TPS54302DDCR		

Designator	Description	Manufacturer / Part	
		Number	
U3	1A Linear Regulator, 16V, SOT-223	TI / TLV76133DCYR	
U4	500mA LDO Regulator, SOIC-8	Analog Devices /	
		LT1763CS8-5TRPBF	
U6	Line Receiver, 16-Pin SOIC	TI / AM26LS32ACDR	
U9	Precision Voltage Ref, 8-Pin SOIC	TI / REF5045AID	
U10	Rail-to-Rail Op Amp, SOIC-8	TI / OPA2350UA/2K5	
U11	Dual Op Amp, SOIC-8	TI / OPA2836IDR	

Table 1: Full Bill of Materials (BOM)

Component Designator	Price (USD)
C1, C2	0.20
C3	0.10
C4, C12, C27, C28	0.38
C5	0.10
C6	0.10
C7	0.60
C8	1.23
C9, C31, C32, C38	0.14
C10	0.53
C11, C33, C37, C39, C41–C43	0.46
C13-C26	0.56
C29, C30, C35, C36	0.64
C34, C40	0.76
DS1	0.28
FB2	0.10
J1	0.12
J2, J4–J6	8.32
Ј3	2.68
L1	1.72
P1	0.40
R1–R14	0.07
R9	0.10
R12	0.03
R15, R17	0.74
R16	0.10
R18	0.02
R19	0.02
R20	0.10

Component Designator	Price (USD)
R21, R22	0.02
R23	0.01
R24	0.02
R25, R27	0.03
R26	0.03
R28, R32	0.20
R29, R33	0.46
R30, R34	0.32
R31	0.22
SW1	0.08
TP1-TP3	0.84
U1	18.05
U2	0.80
U3	0.41
U4	6.71
U6	0.55
U9	4.00
U10	4.54
U11	3.82
Total Component Cost	58.58

Table 2: Component Prices and Total Cost

## 3.3 PCB Layer Stackup

		Material		Туре	Weight	Thickness	Dk
	Top Overlay			Overlay			
	Top Solder	Solder Resist		Solder Mask		0.0127mm	3.8
1	Top Layer			Signal	1oz	0.035mm	
	Dielectric 1	2313	<u></u>	Prepreg		0.1mm	4.05
2	Mid Layer 1			Signal	1/2oz	0.0175mm	
	Core	FR-4		Core		1.265mm	4.5
3	Mid Layer 2			Signal	1/2oz	0.0175mm	
	Dielectric 2	2313	<u></u>	Prepreg		0.1mm	4.05
4	Bottom Layer		-	Signal	1oz	0.035mm	
	Bottom Solder	Solder Resist		Solder Mask		0.0127mm	3.8

Figure 2: PCB Layer Stackup

## 3.4 PCB Layout

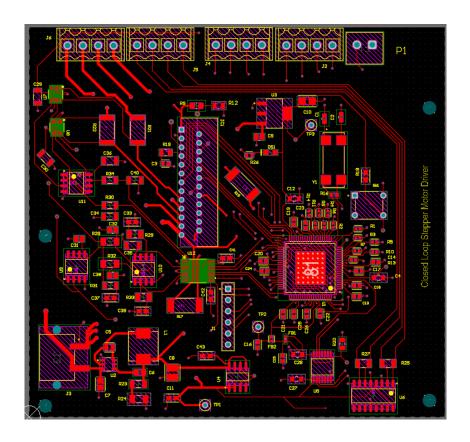


Figure 3: Component Layout



Figure 4: 3D view

PCB design documents can be accessed from this link: https://github.com/Rashane 02/Closed-Loop-Stepper-Motor

## 3.5 Enclosure Design

#### External View

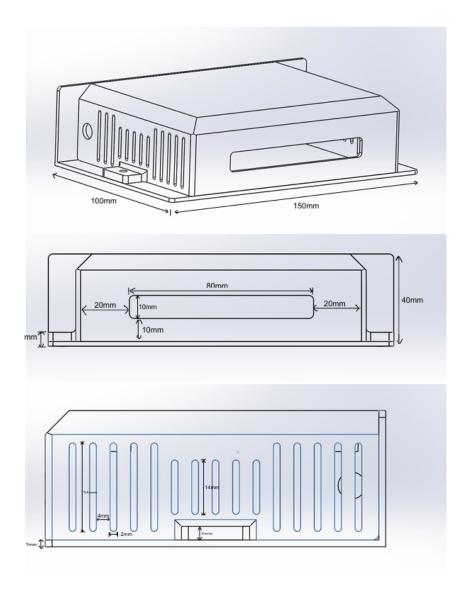


Figure 5: External Parameters

#### Internal View

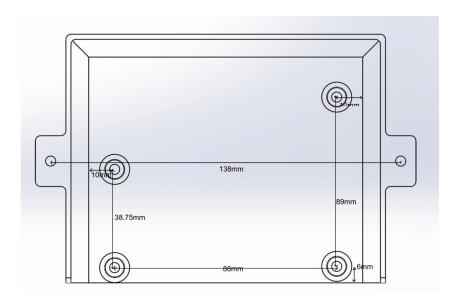


Figure 6: Internal Parameters

#### 3D View

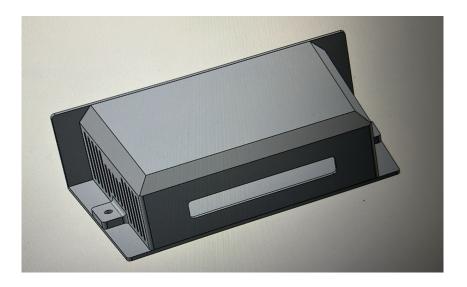


Figure 7: 3D View

Enclosure is manufactured as two parts. The bottom part is made out of metal while the top part is made out of thermoplastic polymer. PCB design documents can be accessed from this link: https://github.com/Rashane02/Closed-Loop-Stepper-Motor

### 4 Software Development

Software development tools used:

- CCS Studio by Texas Instruments
- MATLAB

Programming languages used: C/C++





Code used for programming can be accessed from the link below: https://github.com/Rashane02/Closed-Loop-Stepper-Motor

#### 5 Estimated Cost Per Unit

Category	Cost (USD)
Component Cost (refer table 2)	58.58
PCB Printing Cost	1.40
Enclosure Cost	10.00
Other Costs	10.00
Total Estimated Cost per Unit	79.98

Table 3: Estimated Cost per Unit (USD)

#### 6 Component Datasheets

- TMS320F28069PFPS: https://www.ti.com/lit/gpn/TMS320F28069
- TBH67H400A: https://www.micro-semiconductor.nz/datasheet/de-TB67S149FTG-EL.pdf
- ADS7853: https://www.ti.com/lit/ds/symlink/ads7853.pdf
- INA241B: https://www.ti.com/lit/gpn/INA241B
- REF5045: https://www.ti.com/lit/gpn/ref50
- TLV76133DCYR: https://www.ti.com/lit/gpn/TLV761
- TPS54302DDCR: https://www.ti.com/lit/ds/symlink/tps54302.pdf
- AM26LS32ACDR: https://www.ti.com/lit/ds/symlink/am26ls32a.pdf
- TXS0104EPWR: https://www.ti.com/lit/ds/symlink/txs0104e.pdf